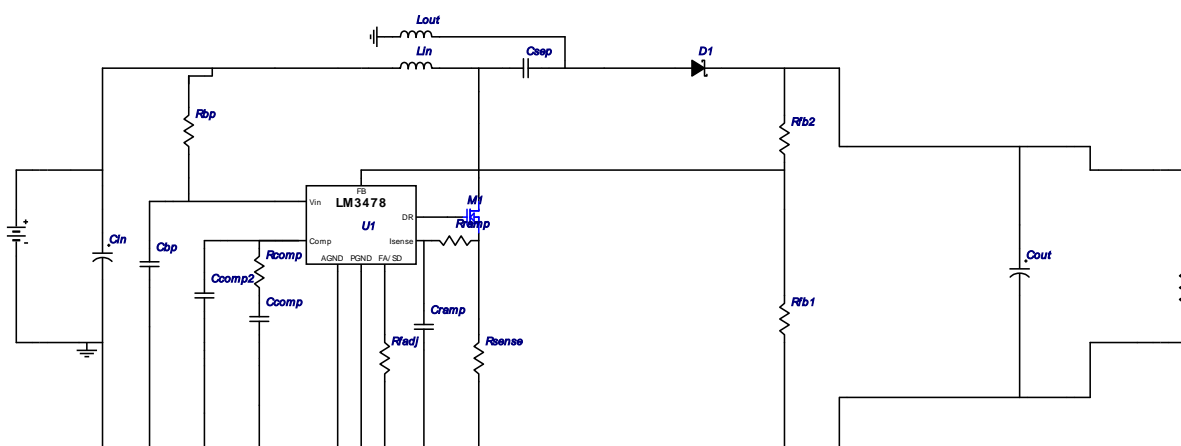



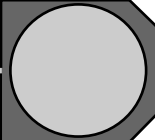
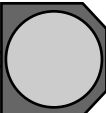





Device = LM3478MM  
Topology = SEPIC  
Created = 4/5/12 6:37:30 AM  
BOM Cost = \$10.25  
Total Pd = 10.88 W  
Footprint = 2,368.0 mm<sup>2</sup>  
BOM Count = 26



#	Name	Manufacturer	Part Number	Quantity	Price	Properties	Footprint
1.	Cbp	MuRata	GRM188R72A104KA35D Series= X7R	1	\$0.03	Cap= 100.0 nF ESR= 0.0 Ohm VDC= 100.0 V IRMS= 0.0 A	 0603 10mm2
2.	Ccomp	MuRata	GRM155R60J334KE01D Series= X5R	1	\$0.02	Cap= 330.0 nF ESR= 0.0 Ohm VDC= 6.3 V IRMS= 0.0 A	 0402 8mm2
3.	Ccomp2	MuRata	GRM2165C1H112JA01D Series= C0G/NP0	1	\$0.02	Cap= 1.1 nF ESR= 0.0 Ohm VDC= 50.0 V IRMS= 0.0 A	 0805 13mm2
4.	Cin	Panasonic	EEV-FK1H331Q Series= FK	3	\$0.48	Cap= 330.0 µF ESR= 120.0 mOhm VDC= 50.0 V IRMS= 900.0 mA	 SM_RADIAL_H13 264mm2
5.	Cout	Nippon Chemi-Con	APXA100ARA561MJC0G Series= PXA	3	\$1.03	Cap= 560.0 µF ESR= 12.0 mOhm VDC= 10.0 V IRMS= 5.3 A	 CAPSMT_62_JC0 156mm2
6.	Cramp	MuRata	GRM2165C2A162JA01D Series= C0G/NP0	1	\$0.02	Cap= 1.6 nF ESR= 0.0 Ohm VDC= 100.0 V IRMS= 0.0 A	 0805 13mm2

#	Name	Manufacturer	Part Number	Quantity	Price	Properties	Footprint
7.	Csep	TDK	C4532X7R1H475M Series= X7R	4	\$0.35	Cap= 4.7 $\mu$ F ESR= 3.0 mOhm VDC= 50.0 V IRMS= 2.9 A	 1812 39mm2
8.	D1	Vishay-Semiconductor	12CWQ10FNPBF	1	\$0.69	VF@Io= 950.0 mV VRRM= 100.0 V	 DPAK 102mm2
9.	Lin	Coilcraft	SER2013-472MLB	1	\$0.95	L= 4.7 $\mu$ H DCR= 1.7 mOhm	 SER2013 438mm2
10.	Lout	Coilcraft	XAL1010-153MEB	1	\$1.08	L= 15.0 $\mu$ H DCR= 20.0 mOhm	 XAL1010 160mm2
11.	M1	Infineon Technologies	BSC110N06NS3G	1	\$0.37	VdsMax= 60.0 V IdsMax= 50.0 Amps	 PG-TDSON-8 55mm2
12.	Rbp	Vishay-Dale	CRCW080520R0FKEA Series= CRCW..e3	1	\$0.01	Res= 20.0 Ohm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
13.	Rcomp	Vishay-Dale	CRCW08051K58FKEA Series= CRCW..e3	1	\$0.01	Res= 1.58 kOhm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
14.	Rfadj	Vishay-Dale	CRCW080586K6FKEA Series= CRCW..e3	1	\$0.01	Res= 86.6 kOhm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
15.	Rfb1	Vishay-Dale	CRCW080510K0FKEA Series= CRCW..e3	1	\$0.01	Res= 10.0 kOhm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
16.	Rfb2	Vishay-Dale	CRCW080539K2FKEA Series= CRCW..e3	1	\$0.01	Res= 39.2 kOhm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
17.	Rramp	Vishay-Dale	CRCW0805100RFKEA Series= CRCW..e3	1	\$0.01	Res= 100.0 Ohm Power= 125.0 mW Tolerance= 1.0%	 0805 13mm2
18.	Rsense	Panasonic	ERJ-M1WSF4M0U Series= 1119	1	\$0.15	Res= 4.0 mOhm Power= 1.0 W Tolerance= 1.0%	 2512 43mm2
19.	U1	Texas Instruments	LM3478MM	1	\$0.93	Switcher	 MUA08A 34mm2

## Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	163.005 m A	Current	Input capacitor RMS ripple current
2.	Cout IRMS	8.371 A	Current	Output capacitor RMS ripple current
3.	Csep IRMS	8.421 A	Current	SEPIC capacitor RMS ripple current
4.	D1 Irms	10.259 A	Current	D1 Irms
5.	IC Ipk	8.062 m A	Current	Peak switch current in IC
6.	Iin Avg	12.096 A	Current	Average input current
7.	Iin Ipk	13.329 A	Current	Iin peak current
8.	Iin Ipp	2.527 A	Current	Peak-to-peak input inductor ripple current
9.	Iin Irms	12.154 A	Current	Iin ripple current
10.	Lout Ipk	6.072 A	Current	Lout peak current
11.	Lout Ipp	790.067 m A	Current	Peak-to-peak output inductor ripple current
12.	Lout Irms	5.711 A	Current	Lout ripple current
13.	M1 Irms	14.625 A	Current	M1 MOSFET Irms

#	Name	Value	Category	Description
14.	BOM Count	26.0	General	Total Design BOM count
15.	FootPrint	2.368 k mm2	General	Total Foot Print Area of BOM components
16.	Frequency	202.5 k Hz	General	Switching frequency
17.	IC Tolerance	24.3 m V	General	IC Feedback Tolerance
18.	Mode	CCM	General	Conduction Mode
19.	Total BOM	\$10.25	General	Total BOM Cost
20.	D1 Tj	92.727 degC	Op_Point	D1 junction temperature
21.	SEPIC Resonance Freq	13.294 k Hz	Op_Point	SEPIC Resonance Frequency
22.	V SEPIC damping factor	109.149 m	Op_Point	V SEPIC damping factor
23.	Vin p-p	20.279 m V	Op_Point	Peak-to-peak input voltage
24.	Vsep p-p	1.055 V	Op_Point	Peak-to-peak sepic voltage
25.	Cross Freq	2.171 k Hz	Op_point	Bode plot crossover frequency
26.	Duty Cycle	67.0 %	Op_point	Duty cycle
27.	Efficiency	77.504 %	Op_point	Steady state efficiency
28.	Gain Marg	11.126 db	Op_point	Bode Plot Gain Margin
29.	IC Tj	88.05 degC	Op_point	IC junction temperature
30.	IOUT_OP	6.0 A	Op_point	Iout operating point
31.	M1 TjOP	30.3 degC	Op_point	M1 MOSFET junction temperature
32.	Phase Marg	69.123 deg	Op_point	Bode Plot Phase Margin
33.	Phase Shift	69.978 deg	Op_point	Bode Plot Phase Shift
34.	VIN_OP	4.0 V	Op_point	Vin operating point
35.	Vout p-p	79.1 m V	Op_point	Peak-to-peak output ripple voltage
36.	Cin Pd	1.063 m W	Power	Input capacitor power dissipation
37.	Cout Pd	280.27 m W	Power	Output capacitor power dissipation
38.	Csep Pd	53.182 m W	Power	SEPIC capacitor power dissipation
39.	D1 Pd	5.702 W	Power	Diode power dissipation
40.	D1 PdCond	5.7 W	Power	Diode conduction losses
41.	D1 PdSw	2.429 m W	Power	Diode switching losses
42.	IC Pd	290.25 m W	Power	IC power dissipation
43.	Lin Pd	280.154 m W	Power	Lin power dissipation
44.	Lout Pd	654.874 m W	Power	Lout power dissipation
45.	M1 Pd	1.567 W	Power	M1 MOSFET total power dissipation
46.	M1 PdCond	1.766 W	Power	M1 MOSFET conduction losses
47.	M1 PdSw	-198.035 m W	Power	M1 MOSFET switching losses
48.	Rsense Pd	855.542 m W	Power	LED Current Rsns Power Dissipation
49.	Total Pd	10.884 W	Power	Total Power Dissipation

## Design Inputs

#	Name	Value	Description
1.	Iout	6.0 A	Maximum Output Current
2.	Iout1	6.0 Amps	Output Current #1
3.	VinMax	36.0 V	Maximum input voltage
4.	VinMin	4.0 V	Minimum input voltage
5.	Vout	6.25 V	Output Voltage
6.	Vout1	6.25 Volt	Output Voltage #1
7.	base_pn	LM3478	National Based Product Number
8.	Ta	30.0 degC	Ambient temperature
9.	UserFsw	202.5 kHz	Customer Selected Frequency

## Design Assistance

1. **LM3478** Product Folder : <http://www.national.com/pf/LM/LM3478.html> : contains the data sheet and other resources.

National's WEBENCH simulation tools attempt to recreate the performance of a substantially equivalent physical implementation of the design. Simulations are created using National's published specifications as well as the published specifications of other device manufacturers. While National does update this information periodically, this information may not be current at the time the simulation is built. National does not warrant the accuracy or completeness of the specifications or any information contained therein. National does not warrant that any designs or recommended parts will meet the specifications you entered, will be suitable for your application or fit for any particular purpose, or will operate as shown in the simulation in a physical implementation. National does not warrant that the designs are production worthy.

**You should completely validate and test your design implementation to confirm the system functionality for your application prior to production.**

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